

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOSHIHISA SONE	04/16/2013
KAZUYA YAMADA	04/16/2013
AKIHIRO TAKEI	04/16/2013
YUICHI YOSHIDA	04/17/2013
KENGO TAKEMASA	04/17/2013
RECEIVING PARTY DATA	
Name:	LAPIS SEMICONDUCTOR CO., LTD.
Street Address:	2-4-8 SHINYOKOHAMA, KOUHOKU-KU
City:	YOKOHAMA
State/Country:	JAPAN
Postal Code:	222-8575
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14997658
CORRESPONDENCE DATA	
Fax Number:	(202)408-0924
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-371-8976
Email:	firm@rabinberdo.com
Correspondent Name:	RABIN & BERDO, P.C.
Address Line 1:	1101 14TH ST., N.W., SUITE 500
Address Line 4:	WASHINGTON, D.C. 20005
ATTORNEY DOCKET NUMBER:	TAI-320C2
NAME OF SUBMITTER:	ROBERT H. BERDO, JR.
SIGNATURE:	/Robert H. Berdo, Jr./
DATE SIGNED:	01/18/2016
Total Attachments: 3	
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ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Toshihisa SONE, Kazuya YAMADA, Akihiro TAKEI, Yuichi YOSHIDA
and Kengo TAKEMASA

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE AND MEASUREMENT DEVICE

[X] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;

[] said application having been filed in the United States Patent and Trademark Office on, _____ authorization being hereby given to the practitioners associated with the Customer Number 23995, to insert here in parentheses (Application Serial No. _____) the application serial number of said application when known;

[] said application having been filed under the Patent Cooperation Treaty on _____, Serial No.) _____, the United States of America being designated.

AND WHEREAS LAPIS Semiconductor Co., Ltd.
of 2-4-8 Shinyokohama, Kouhoku-ku, Yokohama 222-8575, Japan

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

AND Assignors hereby grant the following individuals the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document:

Rabin & Berdo, PC

All practitioners at Customer Number 23995.

AND Assignors acknowledge an obligation of assignment of this invention to Assignee at
Rabin & Berdo, PC

the time the invention was made.

EXECUTED, April 16, 2013

WITNESS:

ASSIGNOR:

Signature: Yoshio Matsuda

Signature: Toshihisa Sone

Name: Toshihisa SONE

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EXECUTED, April 16, 2013

WITNESS:

ASSIGNOR:

Signature: Satoru Ota

Signature: Kazuya Yamada

Name: Kazuya YAMADA

EXECUTED, April 16, 2013

WITNESS:

ASSIGNOR:

Signature: Nobuhiko Tomari

Signature: Akihiro Takei

Name: Akihiro TAKEI

EXECUTED, April 17, 2013

WITNESS:

ASSIGNOR:

Signature: Kenzo Takemasa

Signature: Yuichi Yoshida

Name: Yuichi YOSHIDA

EXECUTED, April 17, 2013.

WITNESS:

ASSIGNOR:

Signature: Yuchin Yoshida

Signature: Kengo Takemasa

Name: Kengo TAKEMASA